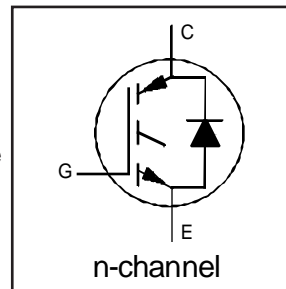


**INSULATED GATE BIPOLAR TRANSISTOR  
WITH ULTRAFAST SOFT RECOVERY DIODE**

Fast CoPack IGBT

**Features**

- Switching-loss rating includes all "tail" losses
- HEXFRED™ soft ultrafast diodes
- Optimized for medium operating frequency (1 to 10kHz) See Fig. 1 for Current vs. Frequency curve



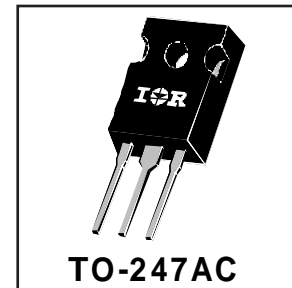
$V_{CES} = 600V$

$V_{CE(sat)} \leq 2.1V$

@  $V_{GE} = 15V, I_C = 17A$

**Description**

Co-packaged IGBTs are a natural extension of International Rectifier's well known IGBT line. They provide the convenience of an IGBT and an ultrafast recovery diode in one package, resulting in substantial benefits to a host of high-voltage, high-current, motor control, UPS and power supply applications.



**Absolute Maximum Ratings**

|                           | Parameter  | Max.                | Units |
|---------------------------|--|---------------------|-------|
| $V_{CES}$                 | Collector-to-Emitter Voltage                     | 600                 | V     |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 31                  | A     |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 17                  |       |
| $I_{CM}$                  | Pulsed Collector Current ①                       | 120                 |       |
| $I_{LM}$                  | Clamped Inductive Load Current ②                 | 120                 |       |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current                 | 12                  |       |
| $I_{FM}$                  | Diode Maximum Forward Current                    | 120                 |       |
| $V_{GE}$                  | Gate-to-Emitter Voltage                          | $\pm 20$            | V     |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 100                 | W     |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 42                  |       |
| $T_J$                     | Operating Junction and Storage Temperature Range | -55 to +150         | °C    |
| $T_{STG}$                 |  |                     |       |
|                           |  |                     |       |
|                           | Mounting Torque, 6-32 or M3 Screw.               | 10 lbf•in (1.1 N•m) |       |

**Thermal Resistance**

|                 | Parameter                                 | Min.  | Typ.     | Max.  | Units  |
|-----------------|---|-------|----------|-------|--------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | ----- | -----    | 1.2   | °C/W   |
| $R_{\theta JC}$ | Junction-to-Case - Diode                  | ----- | -----    | 2.5   |        |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface       | ----- | 0.24     | ----- |        |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | ----- | -----    | 40    |        |
| Wt              | Weight                                    | ----- | 6 (0.21) | ----- | g (oz) |

# IRGPC30FD2



## Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

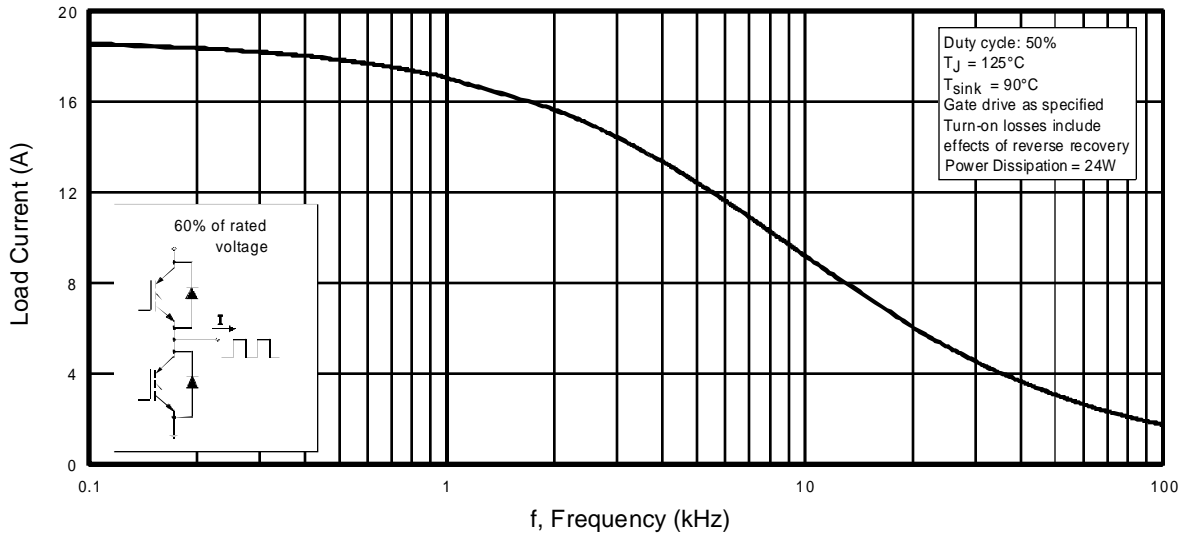
|                                      | Parameter   | Min. | Typ. | Max. | Units | Conditions   |
|--------------------------------------|---|------|------|------|-------|--|
| V <sub>(BR)CES</sub>                 | Collector-to-Emitter Breakdown Voltage <sup>③</sup> | 600  | ---- | ---- | V     | V <sub>GE</sub> = 0V, I <sub>C</sub> = 250μA                         |
| ΔV <sub>(BR)CES/ΔT<sub>J</sub></sub> | Temperature Coeff. of Breakdown Voltage             | ---- | 0.69 | ---- | V/°C  | V <sub>GE</sub> = 0V, I <sub>C</sub> = 1.0mA                         |
| V <sub>CE(on)</sub>                  | Collector-to-Emitter Saturation Voltage             | ---- | 1.8  | 2.1  | V     | I <sub>C</sub> = 17A, V <sub>GE</sub> = 15V                          |
|                                      |   | ---- | 2.4  | ---- |       | I <sub>C</sub> = 31A, V <sub>GE</sub> = 15V                          |
|                                      |   | ---- | 2.2  | ---- |       | I <sub>C</sub> = 17A, T <sub>J</sub> = 150°C                         |
| V <sub>GE(th)</sub>                  | Gate Threshold Voltage                              | 3.0  | ---- | 5.5  |       | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA           |
| ΔV <sub>GE(th)/ΔT<sub>J</sub></sub>  | Temperature Coeff. of Threshold Voltage             | ---- | -11  | ---- | mV/°C | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA           |
| g <sub>fe</sub>                      | Forward Transconductance <sup>④</sup>               | 6.1  | 10   | ---- | S     | V <sub>CE</sub> = 100V, I <sub>C</sub> = 17A                         |
| I <sub>CES</sub>                     | Zero Gate Voltage Collector Current                 | ---- | ---- | 250  | μA    | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V                         |
|                                      |   | ---- | ---- | 2500 |       | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V, T <sub>J</sub> = 150°C |
| V <sub>FM</sub>                      | Diode Forward Voltage Drop                          | ---- | 1.4  | 1.7  | V     | I <sub>C</sub> = 12A, V <sub>GE</sub> = 15V                          |
|                                      |   | ---- | 1.3  | 1.6  |       | I <sub>C</sub> = 12A, T <sub>J</sub> = 150°C                         |
| I <sub>GES</sub>                     | Gate-to-Emitter Leakage Current                     | ---- | ---- | ±100 | nA    | V <sub>GE</sub> = ±20V   |

## Switching Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

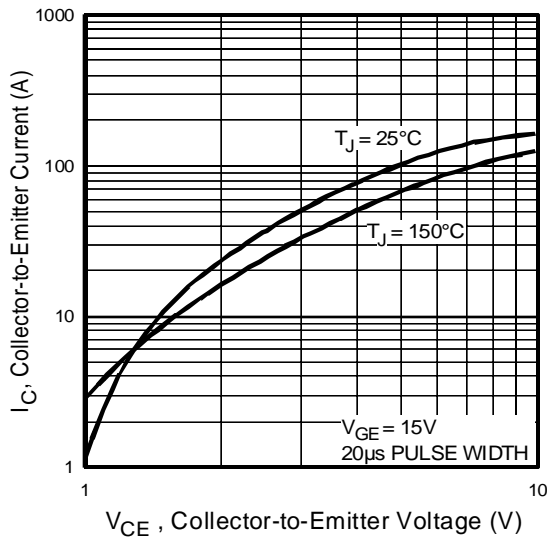
|                     | Parameter  | Min. | Typ.                              | Max. | Units | Conditions   |
|---------------------|--|------|-----------------------------------|------|-------|--|
| Q <sub>g</sub>      | Total Gate Charge (turn-on)                                | ---- | 27                                | 30   | nC    | I <sub>C</sub> = 17A                                     |
| Q <sub>ge</sub>     | Gate - Emitter Charge (turn-on)                            | ---- | 4.1                               | 5.9  |       | V <sub>CC</sub> = 400V                                   |
| Q <sub>gc</sub>     | Gate - Collector Charge (turn-on)                          | ---- | 12                                | 15   |       | See Fig. 8   |
| t <sub>d(on)</sub>  | Turn-On Delay Time   | ---- | 72                                | ---- | ns    | T <sub>J</sub> = 25°C                                    |
| t <sub>r</sub>      | Rise Time  | ---- | 75                                | ---- |       | I <sub>C</sub> = 17A, V <sub>CC</sub> = 480V             |
| t <sub>d(off)</sub> | Turn-Off Delay Time  | ---- | 300                               | 450  |       | V <sub>GE</sub> = 15V, R <sub>G</sub> = 23Ω              |
| t <sub>f</sub>      | Fall Time  | ---- | 220                               | 350  | mJ    | Energy losses include "tail" and diode reverse recovery. |
| E <sub>on</sub>     | Turn-On Switching Loss                                     | ---- | 0.9                               | ---- |       | See Fig. 9, 10, 11, 18                                   |
| E <sub>off</sub>    | Turn-Off Switching Loss                                    | ---- | 2.1                               | ---- |       |  |
| E <sub>ts</sub>     | Total Switching Loss                                       | ---- | 3.0                               | 4.6  | mJ    |  |
| t <sub>d(on)</sub>  | Turn-On Delay Time   | ---- | 70                                | ---- |       | T <sub>J</sub> = 150°C, See Fig. 9, 10, 11, 18           |
| t <sub>r</sub>      | Rise Time  | ---- | 75                                | ---- |       | I <sub>C</sub> = 17A, V <sub>CC</sub> = 480V             |
| t <sub>d(off)</sub> | Turn-Off Delay Time  | ---- | 420                               | ---- | ns    | V <sub>GE</sub> = 15V, R <sub>G</sub> = 23Ω              |
| t <sub>f</sub>      | Fall Time  | ---- | 480                               | ---- |       | Energy losses include "tail" and diode reverse recovery. |
| E <sub>ts</sub>     | Total Switching Loss                                       | ---- | 4.7                               | ---- |       |  |
| L <sub>E</sub>      | Internal Emitter Inductance                                | ---- | 13                                | ---- | nH    | Measured 5mm from package                                |
| C <sub>ies</sub>    | Input Capacitance  | ---- | 670                               | ---- | pF    | V <sub>GE</sub> = 0V                                     |
| C <sub>oes</sub>    | Output Capacitance   | ---- | 100                               | ---- |       | V <sub>CC</sub> = 30V                                    |
| C <sub>res</sub>    | Reverse Transfer Capacitance                               | ---- | 10                                | ---- |       | f = 1.0MHz   |
| t <sub>rr</sub>     | Diode Reverse Recovery Time                                | ---- | 42                                | 60   | ns    | T <sub>J</sub> = 25°C See Fig. 14                        |
|                     |  | ---- | 80                                | 120  |       | T <sub>J</sub> = 125°C                                   |
| I <sub>rr</sub>     | Diode Peak Reverse Recovery Current                        | ---- | 3.5                               | 6.0  | A     | T <sub>J</sub> = 25°C See Fig. 15                        |
|                     |  | ---- | 5.6                               | 10   |       | T <sub>J</sub> = 125°C                                   |
| Q <sub>rr</sub>     | Diode Reverse Recovery Charge                              | ---- | 80                                | 180  | nC    | T <sub>J</sub> = 25°C See Fig. 16                        |
|                     |  | ---- | 220                               | 600  |       | T <sub>J</sub> = 125°C                                   |
| μs                  | d <sub>(rec)</sub> /dt Diode Peak Rate of Fall of Recovery | ---- | ----                              | ---- | ----  | 180  |
|                     |  | A/μs | T <sub>J</sub> = 25°C See Fig. 17 | ---- |       | During t <sub>b</sub>                                    |

### Notes:

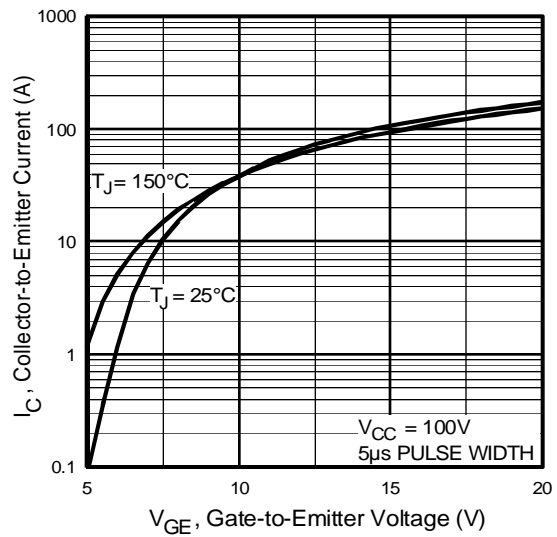
- ① Repetitive rating; V<sub>GE</sub>=20V, pulse width limited by max. junction temperature. ( See fig. 20 )
- ② V<sub>CC</sub>=80%(V<sub>CES</sub>), V<sub>GE</sub>=20V, L=10μH, R<sub>G</sub> = 23Ω, ( See fig. 19 )
- ③ Pulse width ≤ 80μs; duty factor ≤ 0.1%.
- ④ Pulse width 5.0μs, single shot.



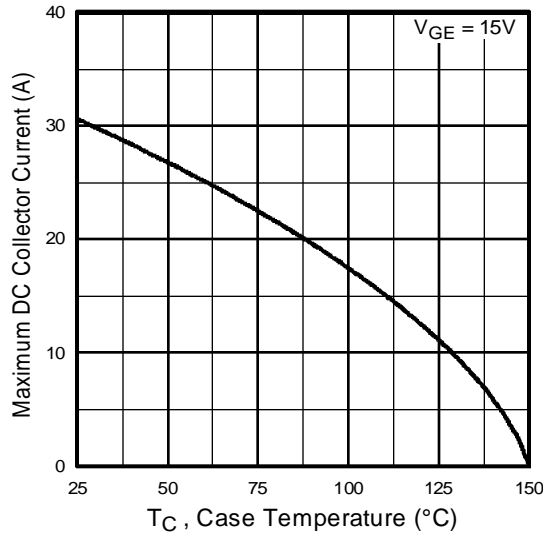
**Fig. 1 - Typical Load Current vs. Frequency**  
(Load Current =  $I_{RMS}$  of fundamental)



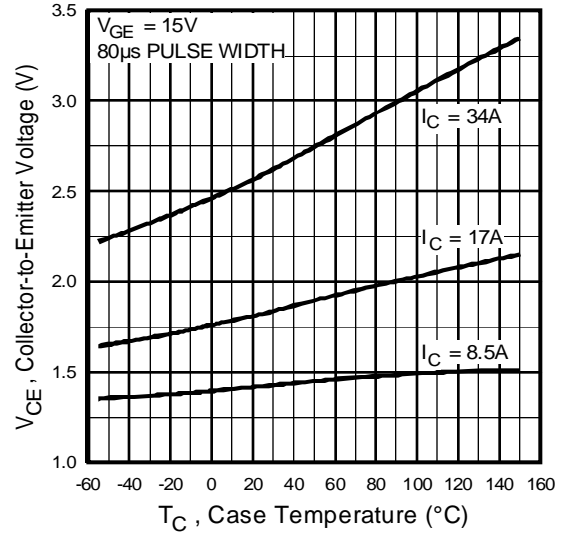
**Fig. 2 - Typical Output Characteristics**



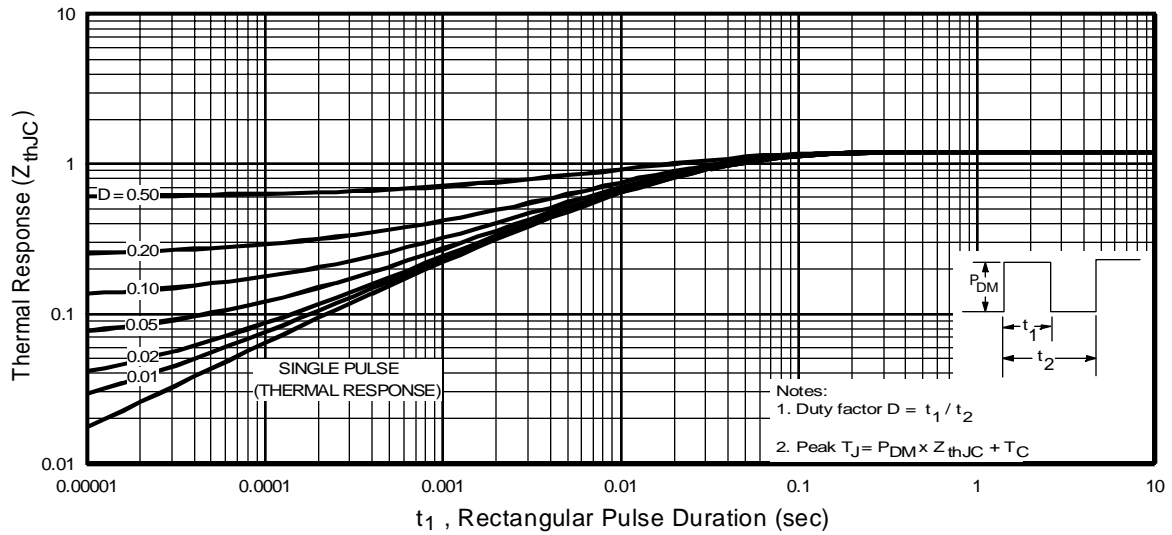
**Fig. 3 - Typical Transfer Characteristics**



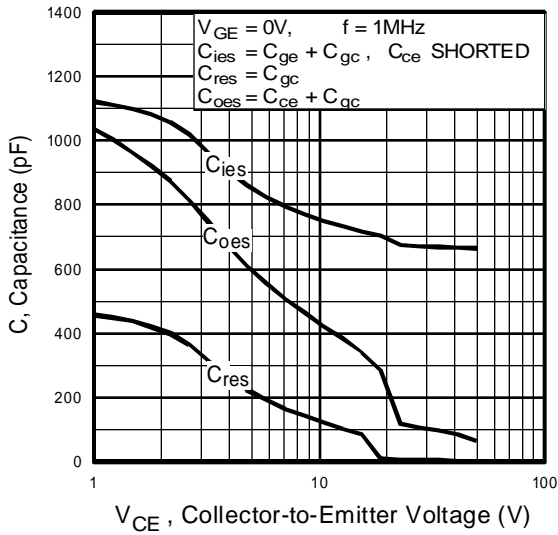
**Fig. 4** - Maximum Collector Current vs. Case Temperature



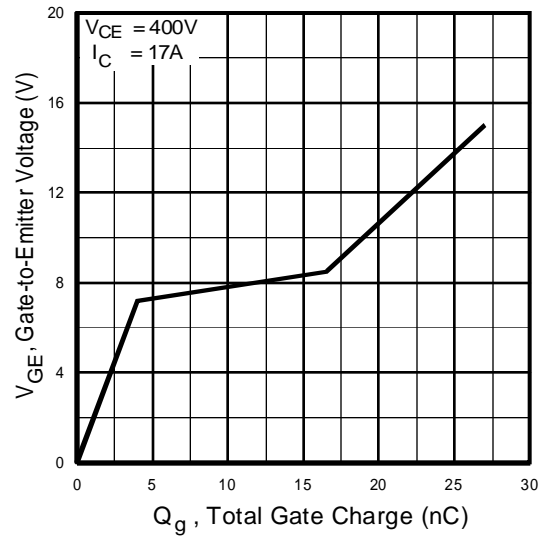
**Fig. 5** - Collector-to-Emitter Voltage vs. Case Temperature



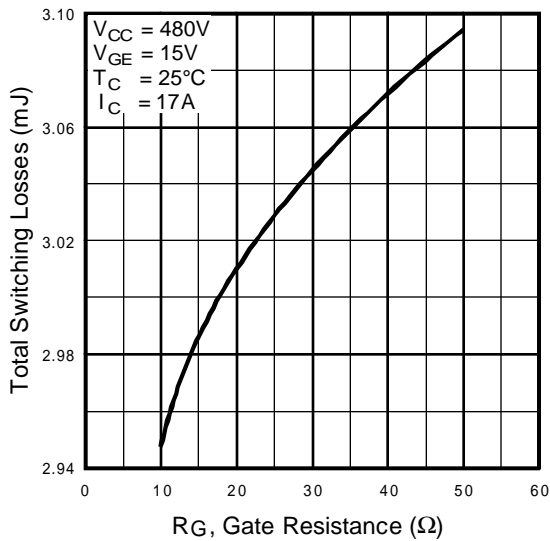
**Fig. 6** - Maximum IGBT Effective Transient Thermal Impedance, Junction-to-Case



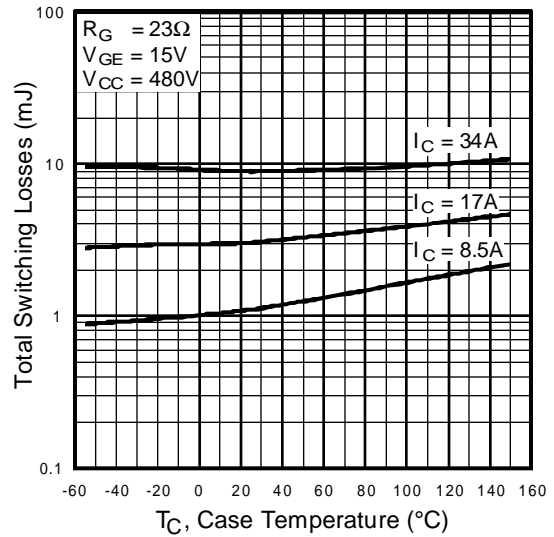
**Fig. 7** - Typical Capacitance vs. Collector-to-Emitter Voltage



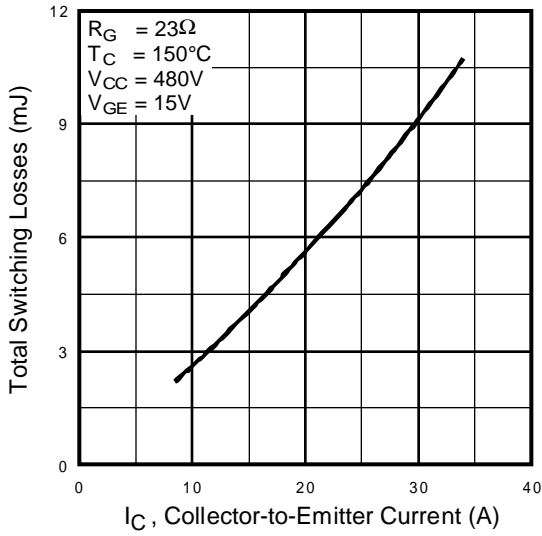
**Fig. 8** - Typical Gate Charge vs. Gate-to-Emitter Voltage



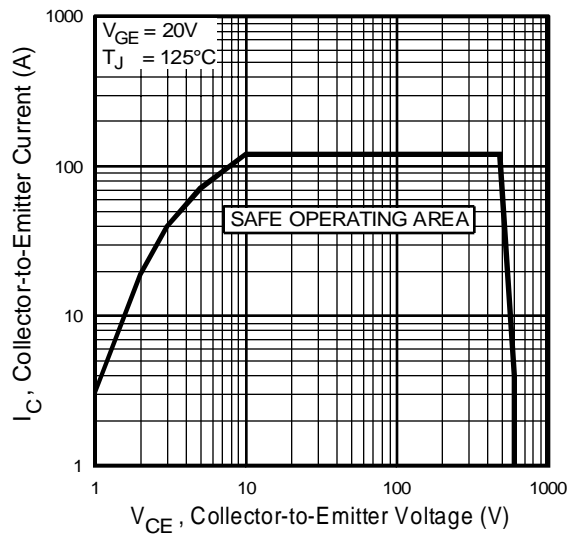
**Fig. 9** - Typical Switching Losses vs. Gate Resistance



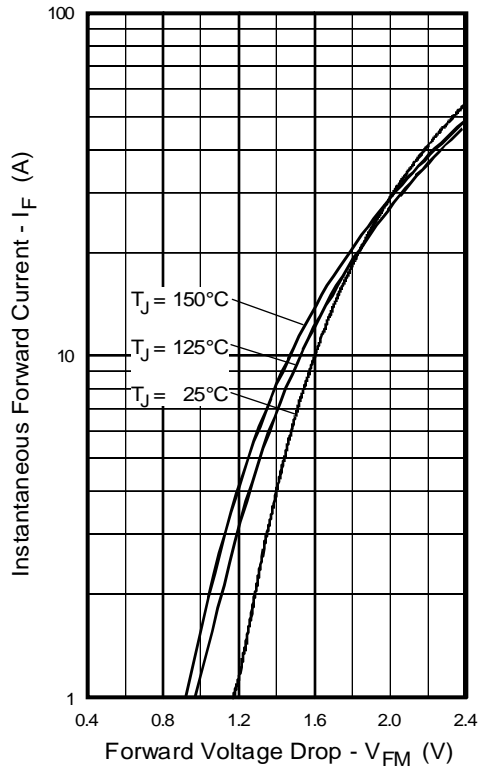
**Fig. 10** - Typical Switching Losses vs. Case Temperature



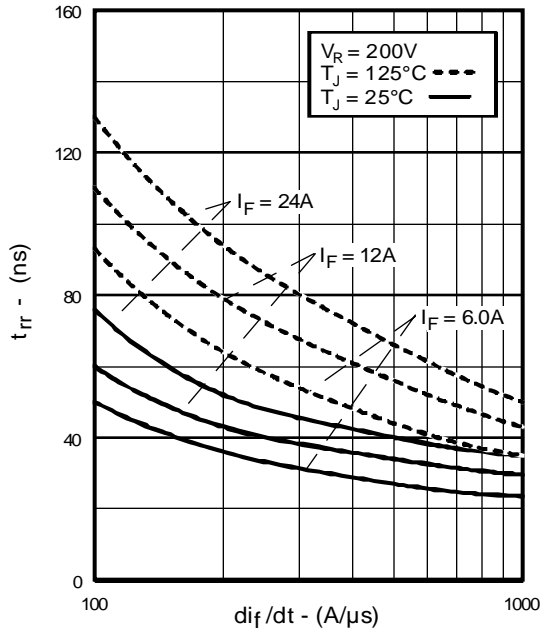
**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



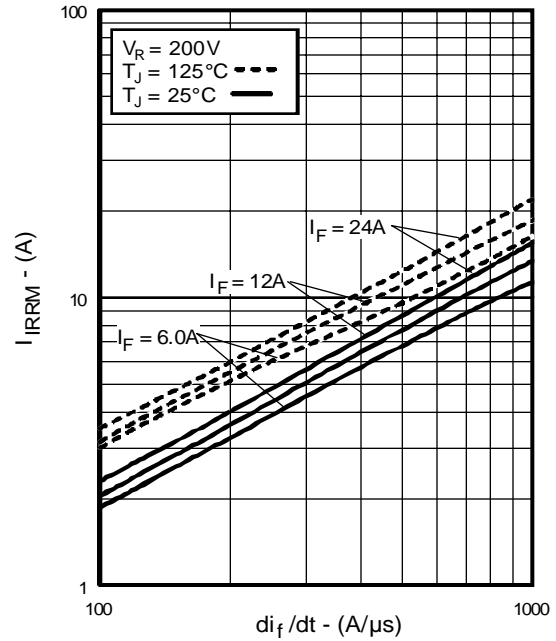
**Fig. 12** - Turn-Off SOA



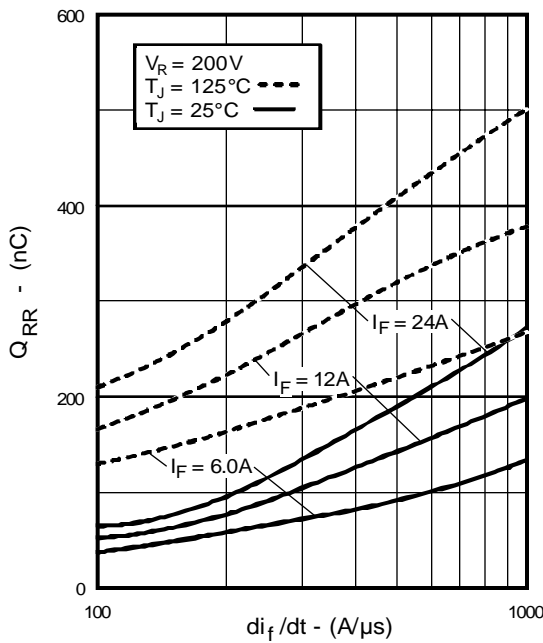
**Fig. 13** - Maximum Forward Voltage Drop vs. Instantaneous Forward Current



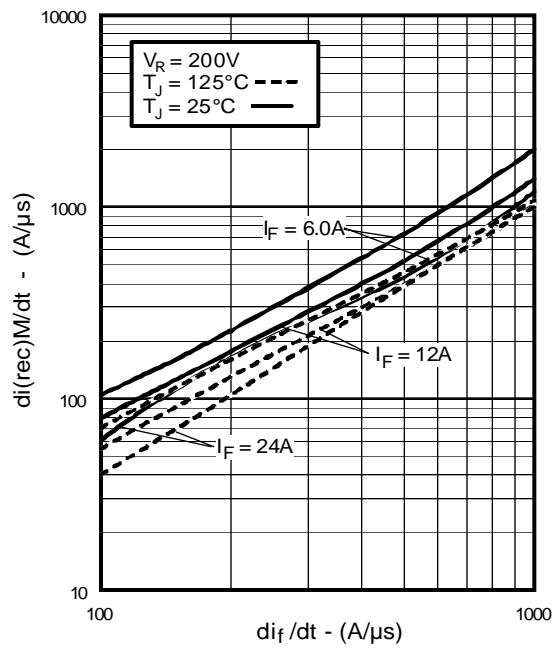
**Fig. 14** - Typical Reverse Recovery vs.  $di_f/dt$



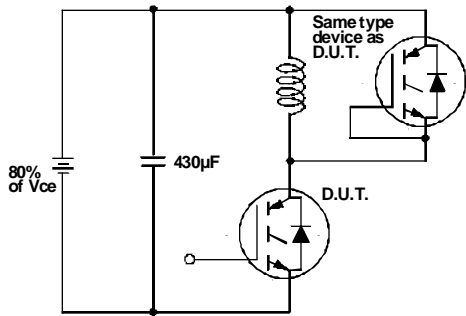
**Fig. 15** - Typical Recovery Current vs.  $di_f/dt$



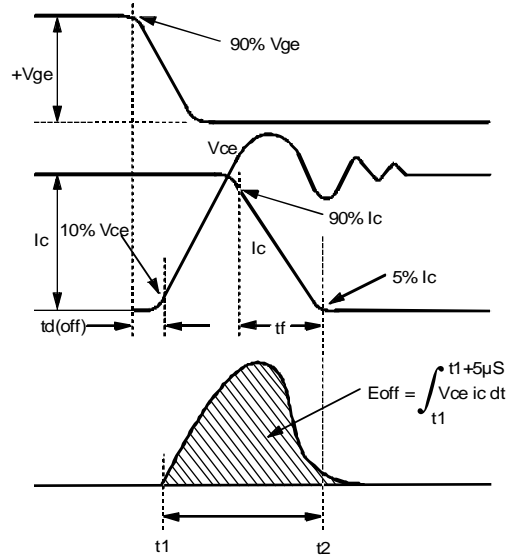
**Fig. 16** - Typical Stored Charge vs.  $di_f/dt$



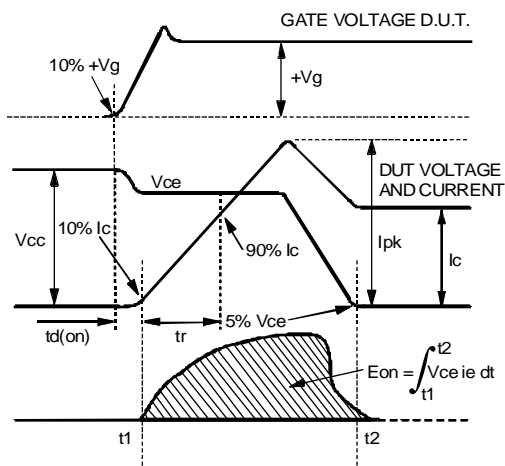
**Fig. 17** - Typical  $di_{(rec)M}/dt$  vs.  $di_f/dt$



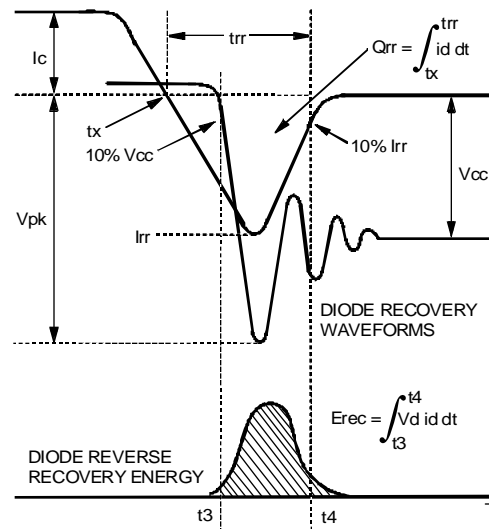
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off}(\text{diode})$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$

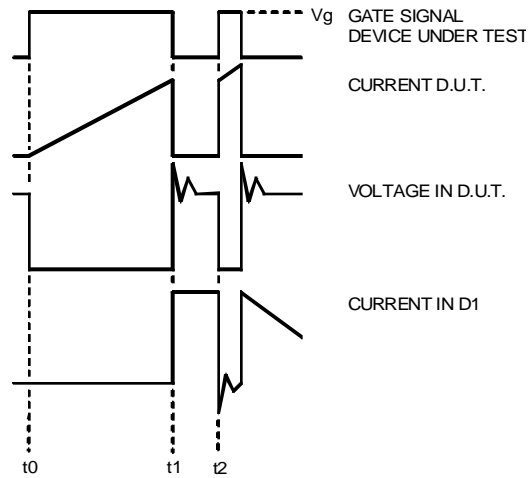


**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$

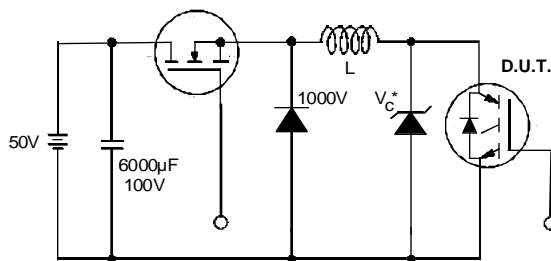




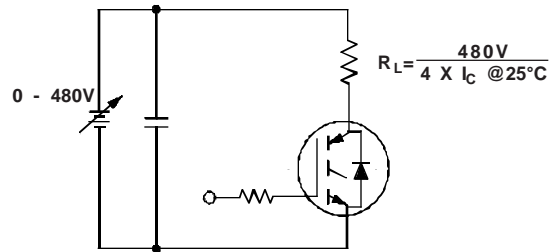
# IRGPC30FD2



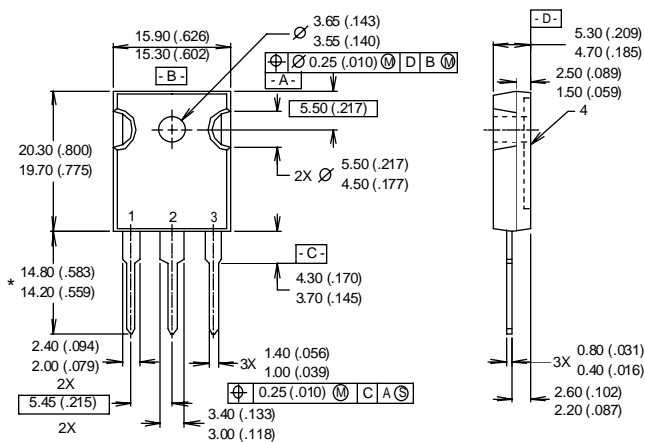
**Fig. 18e - Macro Waveforms for Test Circuit of Fig. 18a**



**Fig. 19 - Clamped Inductive Load Test Circuit**



**Fig. 20 - Pulsed Collector Current Test Circuit**



- NOTES:
- 1 DIMENSIONS & TOLERANCING PER ANSI Y14.5M, 1982.
  - 2 CONTROLLING DIMENSION: INCH.
  - 3 DIMENSIONS ARE SHOWN MILLIMETERS (INCHES).
  - 4 CONFORMS TO JEDEC OUTLINE TO-247AC.

- LEAD ASSIGNMENTS
- 1 - GATE
  - 2 - COLLECTOR
  - 3 - EMITTER
  - 4 - COLLECTOR

\* LONGER LEADED (20mm) VERSION AVAILABLE (TO-247AD) TO ORDER ADD "-E" SUFFIX TO PART NUMBER

**CONFORMS TO JEDEC OUTLINE TO-247AC (TO-3P)**  
Dimensions in Millimeters and (Inches)